

General Description

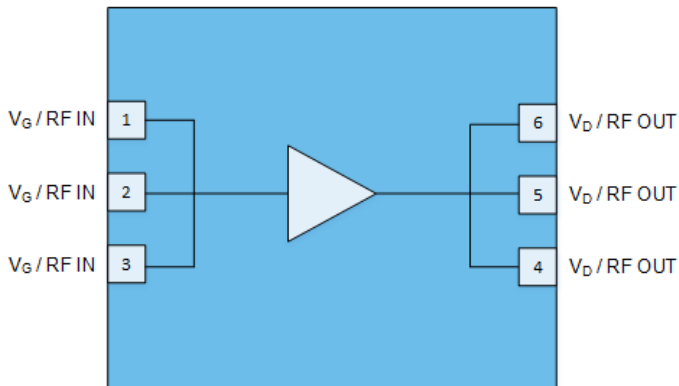
The Qorvo QPD1013 is a 150 W (P_{3dB}) discrete GaN on SiC HEMT which operates from DC to 2.7 GHz. This is a single stage unmatched power amplifier transistor in an over-molded plastic package. The high power and wide bandwidth of the QPD1013 makes it suitable for many different applications from DC to 2.7 GHz.

The device is housed in an industry-standard 7.2 x 6.6 mm surface mount DFN package.

Lead-free and ROHS compliant

Evaluation boards are available upon request.

Functional Block Diagram



6 Pin DFN (7.2 x 6.6 x 0.9 mm)

Product Features

- Frequency: DC to 2.7 GHz
 - Output Power (P_{3dB}): 178 W¹
 - Linear Gain: 21.8 dB¹
 - Typical PAE_{3dB}: 64.8 %¹
 - Operating Voltage: 65 V
 - Low thermal resistance package
 - CW and Pulse capable
 - 7.2 x 6.6 mm package
- Note 1: @ 1.8 GHz (Loadpull)

Applications

- Military radar
- Land mobile and military radio communications
- Test instrumentation
- Wideband or narrowband amplifiers
- Jammers

Ordering info

Part No.	ECCN	Description
QPD1013S2	EAR99	2 Piece Sample Bag
QPD1013SQ	EAR99	25 Piece Sample Bag
QPD1013SR	EAR99	100 Piece 7" Reel
QPD1013EVB01	EAR99	1.2 – 1.9 GHz EVB

Absolute Maximum Ratings²

Parameter	Rating	Units
Breakdown Voltage, BV_{DG}	225	V
Gate Voltage Range, V_G	-8 to +2	V
Drain Current, I_D	9	A
Gate Current Range, I_G^1	19.2	mA
Power Dissipation, CW, P_{DISS}	74	W
RF Input Power at 1.6 GHz, CW, 50 Ω , T = 25 °C	+39	dBm
Channel Temperature, T_{CH}	275	°C
Mounting Temperature (30 Seconds)	320	°C
Storage Temperature	-65 to +150	°C

Notes:

1. At Channel temperature of 200°C.
2. Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions¹

Parameter	Min	Typ	Max	Units
Operating Temp. Range	-40	+25	+85	°C
Drain Voltage Range, V_D	-	+65	+70	V
Drain Bias Current, I_{DQ}	-	240	-	mA
Drain Current, I_D	-	1.7	-	A
Gate Voltage, V_G^4	-	-2.8	-	V
Channel Temperature (T_{CH})	-	-	250	°C
Power Dissipation, CW (P_D) ²	-	-	67.0	W
Power Dissipation, Pulsed (P_D) ^{2, 3}	-	-	120.0	W

Notes:

1. Electrical performance is measured under conditions noted in the electrical specifications table. Specifications are not guaranteed over all recommended operating conditions.
2. Back plane of package at 85 °C
3. Pulse Width = 100 μ s, Duty Cycle = 10%
4. To be adjusted to desired I_{DQ}

**Pulsed Characterization – Load Pull Performance – Power Tuned – 65 V¹**

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.3	2.7	GHz
Linear Gain, G _{LIN}	23.7	22.3	20.3	18.1	15.2	dB
Output Power at 3dB compression point, P _{3dB}	52.7	52.5	52.5	52.3	52.1	dBm
Power-Added-Efficiency at 3dB compression point, PAE _{3dB}	61.5	58.1	53.7	51.1	43.2	%
Gain at 3dB compression point	20.7	19.3	17.3	15.1	12.2	dB

Notes:

1. Test conditions unless otherwise noted: V_D = +65 V, I_{DQ} = 240 mA, Temp = +25 °C

Pulsed Characterization – Load Pull Performance – Efficiency Tuned – 65 V¹

Parameters	Typical Values					Unit
Frequency	1.2	1.5	1.8	2.3	2.7	GHz
Linear Gain, G _{LIN}	25.3	23.7	21.8	19.3	16.8	dB
Output Power at 3dB compression point, P _{3dB}	50.6	50.2	51.1	51.1	50.9	dBm
Power-Added-Efficiency at 3dB compression point, PAE _{3dB}	70.9	69.4	64.8	57.5	52.3	%
Gain at 3dB compression point	22.3	20.7	18.8	16.3	13.8	dB

Notes:

- 1- Test conditions unless otherwise noted: V_D = +65 V, I_{DQ} = 240 mA, Temp = +25 °C

Pulsed Characterization – Load Pull Performance – Power Tuned – 50 V¹

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.7		GHz
Linear Gain, G _{LIN}	22.5	21.9	19.7	15.2		dB
Output Power at 3dB compression point, P _{3dB}	51.5	51.5	51.6	51.4		dBm
Power-Added-Efficiency at 3dB compression point, PAE _{3dB}	62.8	56.8	50.5	50.9		%
Gain at 3dB compression point	19.5	18.9	16.7	12.2		dB

Notes:

1. Test conditions unless otherwise noted: V_D = +50 V, I_{DQ} = 240 mA, Temp = +25 °C

Pulsed Characterization – Load Pull Performance – Efficiency Tuned – 50 V¹

Parameters	Typical Values					Unit
Frequency, F	1.2	1.5	1.8	2.7		GHz
Linear Gain, G _{LIN}	23.7	23.3	21.0	16.2		dB
Output Power at 3dB compression point, P _{3dB}	49.9	50.4	49.6	50.8		dBm
Power-Added-Efficiency at 3dB compression point, PAE _{3dB}	73.1	67.7	64.6	58.1		%
Gain at 3dB compression point	20.7	20.3	18.0	13.2		dB

Notes:

1. Test conditions unless otherwise noted: V_D = +50 V, I_{DQ} = 240 mA, Temp = +25 °C

RF Characterization – 1.2 – 1.9 GHz EVB Performance At 1.6 GHz¹

Parameter	Min	Typ	Max	Units
Linear Gain, G_{LIN}	–	16.6	–	dB
Output Power at 3dB compression point, P_{3dB}	–	51.9	–	dBm
Drain Efficiency at 3dB compression point, $DEFF_{3dB}$	–	55.3	–	%
Gain at 3dB compression point, G_{3dB}	–	13.6	–	dB

Notes:

1. $V_D = +65\text{ V}$, $I_{DQ} = 240\text{ mA}$, Temp = $+25\text{ }^\circ\text{C}$, Pulse Width = 100 us, Duty Cycle = 10%

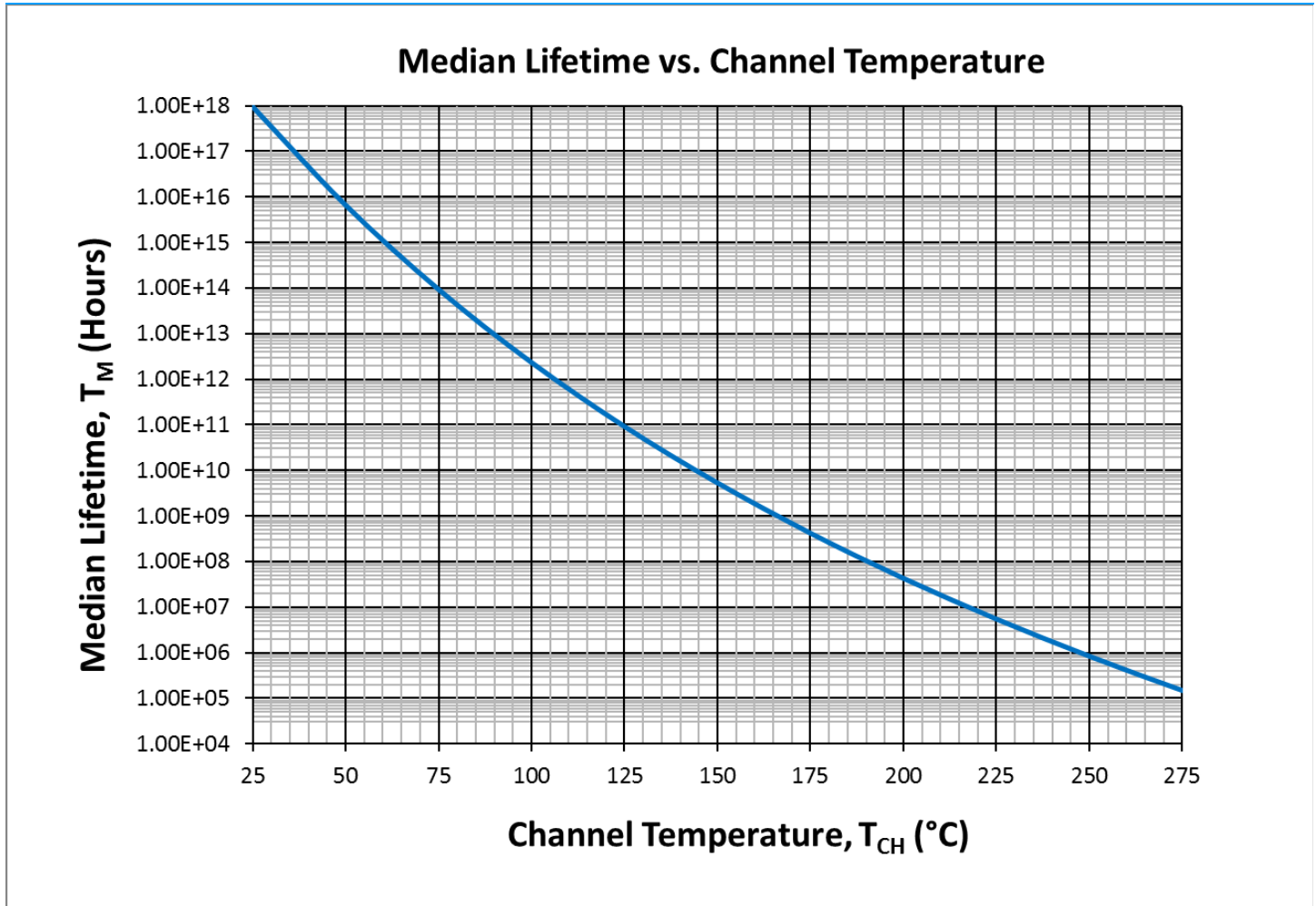
RF Characterization – Mismatch Ruggedness at 1.6 GHz^{1,2}

Symbol	Parameter	dB Compression	Typical
VSWR	Impedance Mismatch Ruggedness	3	10:1

Notes:

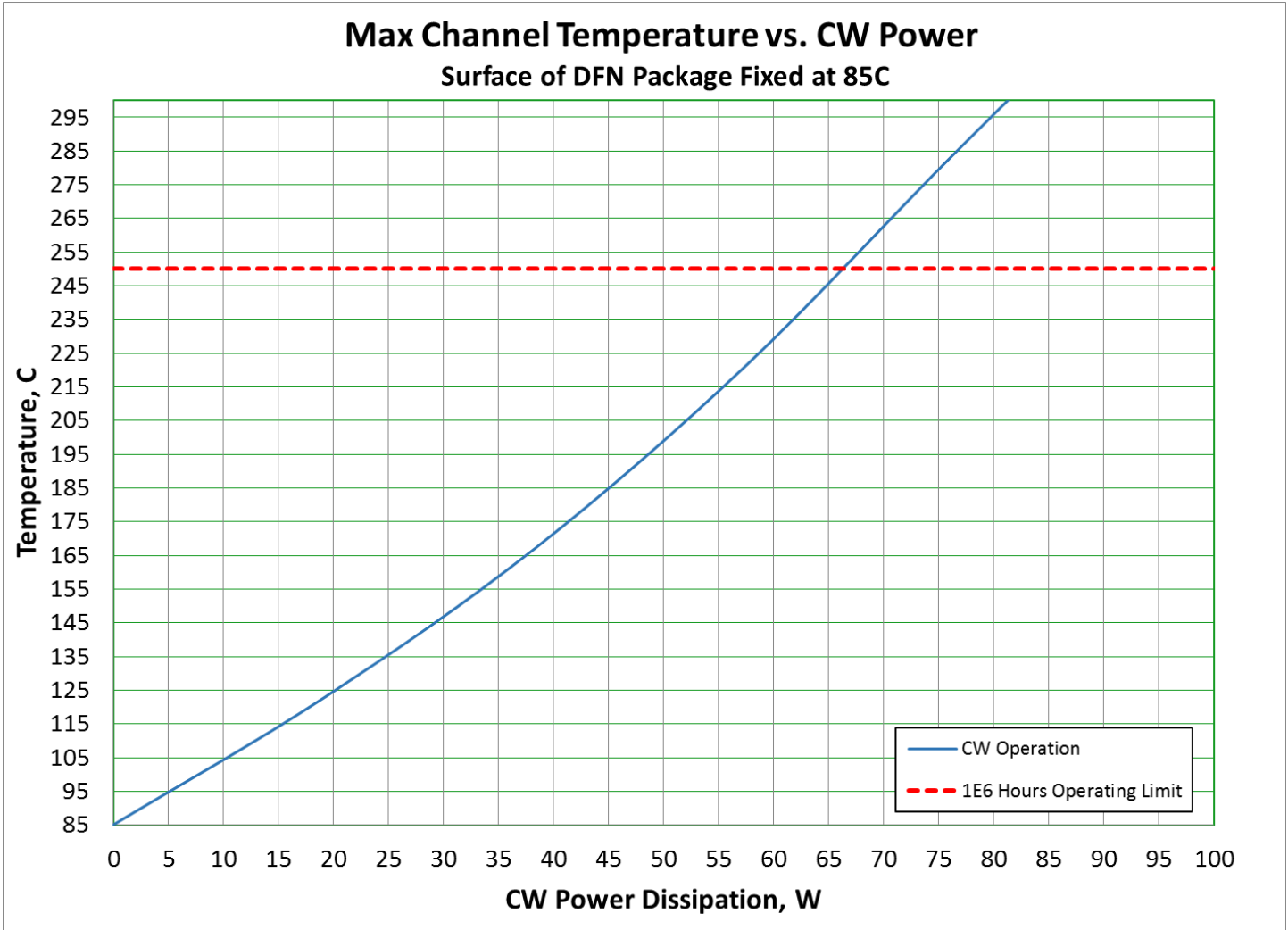
- 1- Test conditions unless otherwise noted: $T_A = 25\text{ }^\circ\text{C}$, $V_D = 65\text{ V}$, $I_{DQ} = 240\text{ mA}$
- 2- Driving input power is determined at pulsed compression under matched condition at EVB output connector.

Median Lifetime¹

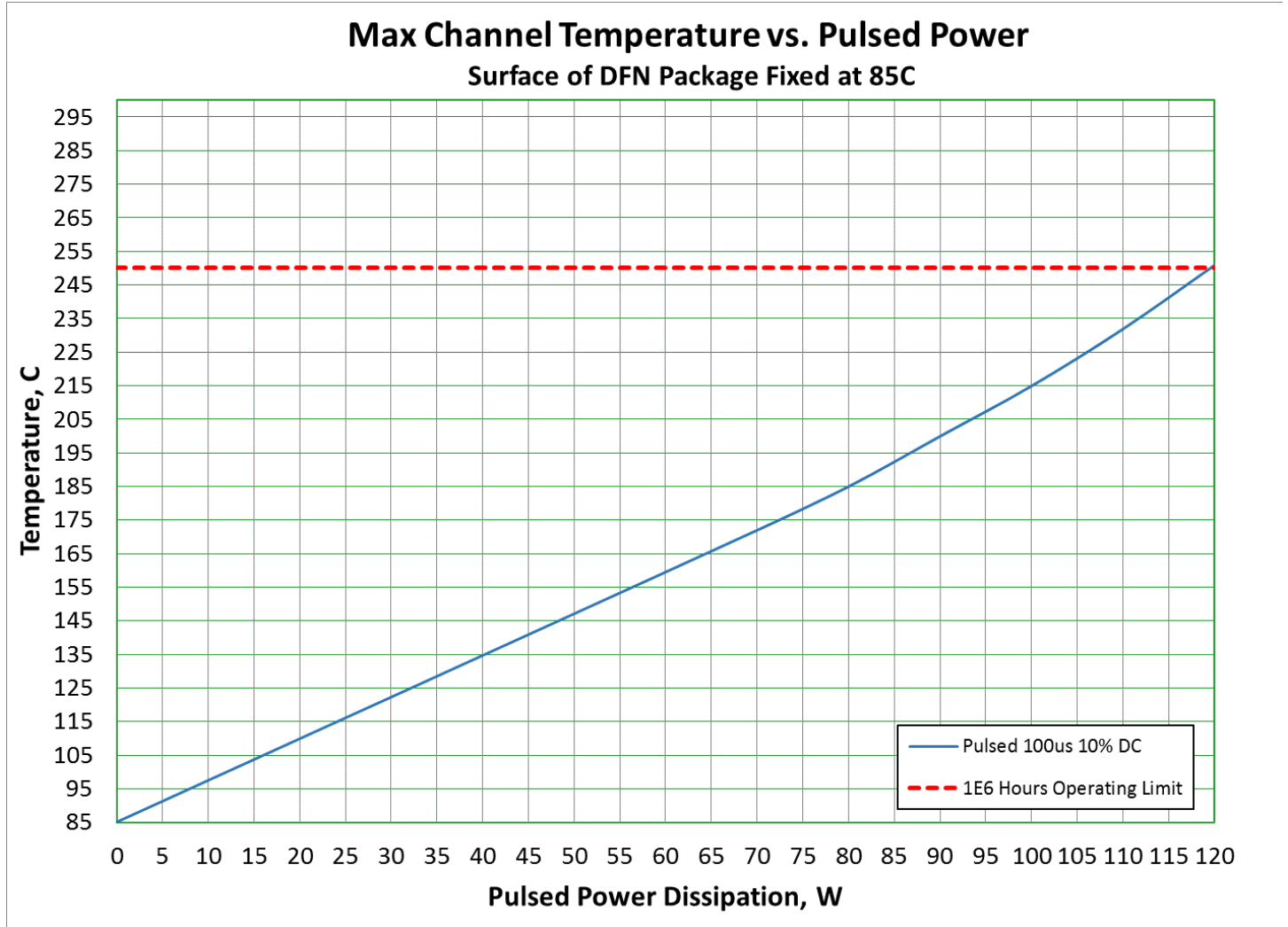


Notes:

- 1- For pulsed signals, average lifetime is average lifetime at maximum channel temperature divided by duty cycle.

Thermal and Reliability Information - CW


Parameter	Conditions	Values	Units
Thermal Resistance (θ_{JC})	85 °C Case	2.0	°C/W
Maximum Channel Temperature (T_{CH})	19.2 W Pdiss, CW	124	°C
Median Lifetime (T_M)		9.0E10	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	2.2	°C/W
Maximum Channel Temperature (T_{CH})	38.4 W Pdiss, CW	168	°C
Median Lifetime (T_M)		7.0E8	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	2.4	°C/W
Maximum Channel Temperature (T_{CH})	57.6 W Pdiss, CW	222	°C
Median Lifetime (T_M)		7.0E6	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	2.6	°C/W
Maximum Channel Temperature (T_{CH})	76.8 W Pdiss, CW	285	°C
Median Lifetime (T_M)		7.0E4	Hrs

Thermal and Reliability Information - Pulsed


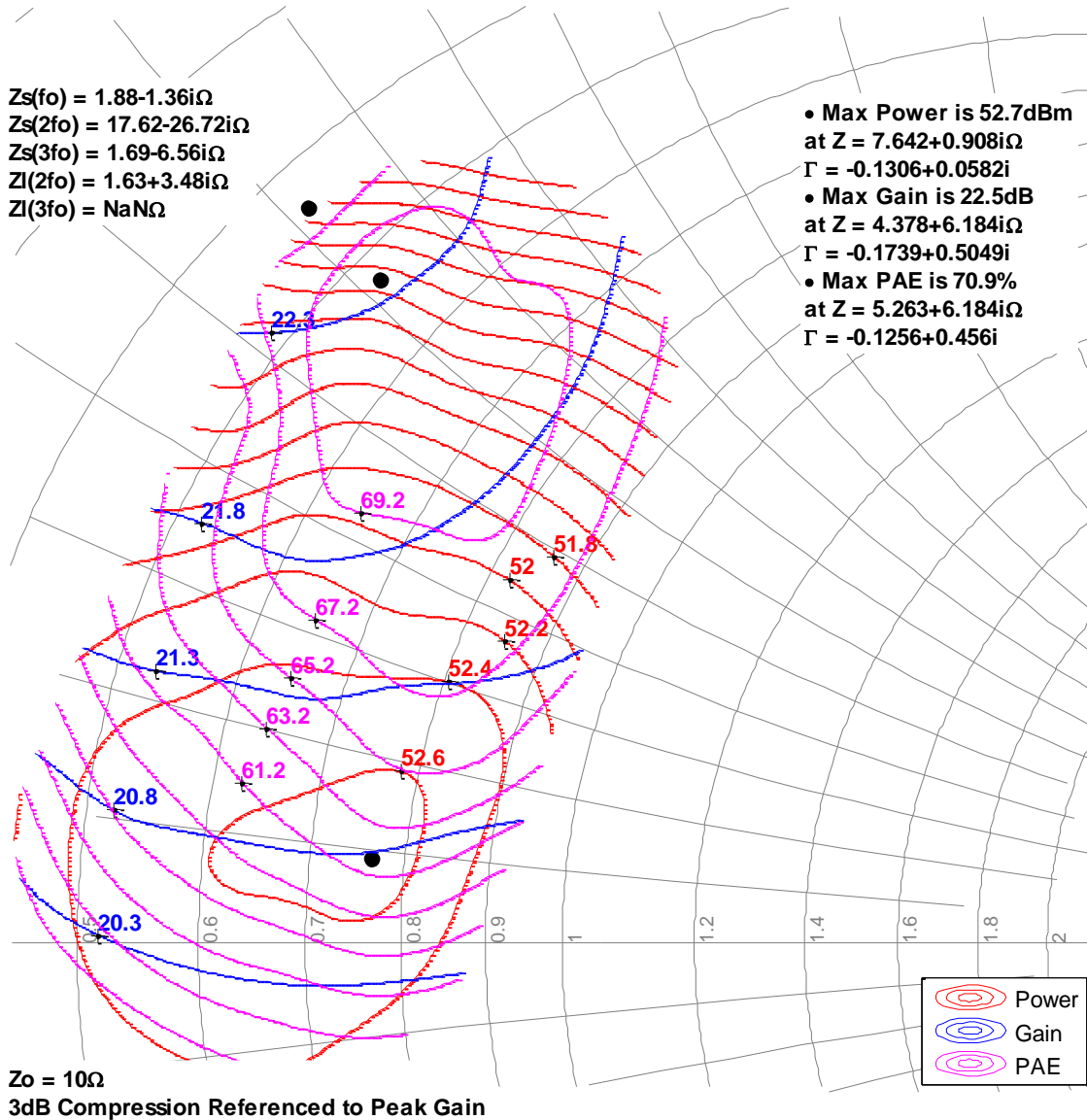
Parameter	Conditions	Values	Units
Thermal Resistance (θ_{JC})	85 °C Case	2.0	°C/W
Maximum Channel Temperature (T_{CH})	90 W Pdiss, Pulsed 100us 10% DC	200	°C
Median Lifetime (T_M)		4.0E8	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	1.7	°C/W
Maximum Channel Temperature (T_{CH})	100 W Pdiss, Pulsed 100us 10% DC	215	°C
Median Lifetime (T_M)		1.0E8	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	1.5	°C/W
Maximum Channel Temperature (T_{CH})	110 W Pdiss, Pulsed 100us 10% DC	232	°C
Median Lifetime (T_M)		3.0E7	Hrs
Thermal Resistance (θ_{JC})	85 °C Case	1.4	°C/W
Maximum Channel Temperature (T_{CH})	120 W Pdiss, Pulsed 100us 10% DC	251	°C
Median Lifetime (T_M)		8.0E6	Hrs

Load Pull Smith Charts^{1,2}

Notes:

1. $V_d = 65\text{ V}$, $I_{bQ} = 240\text{ mA}$, Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

1.2GHz, Load-pull

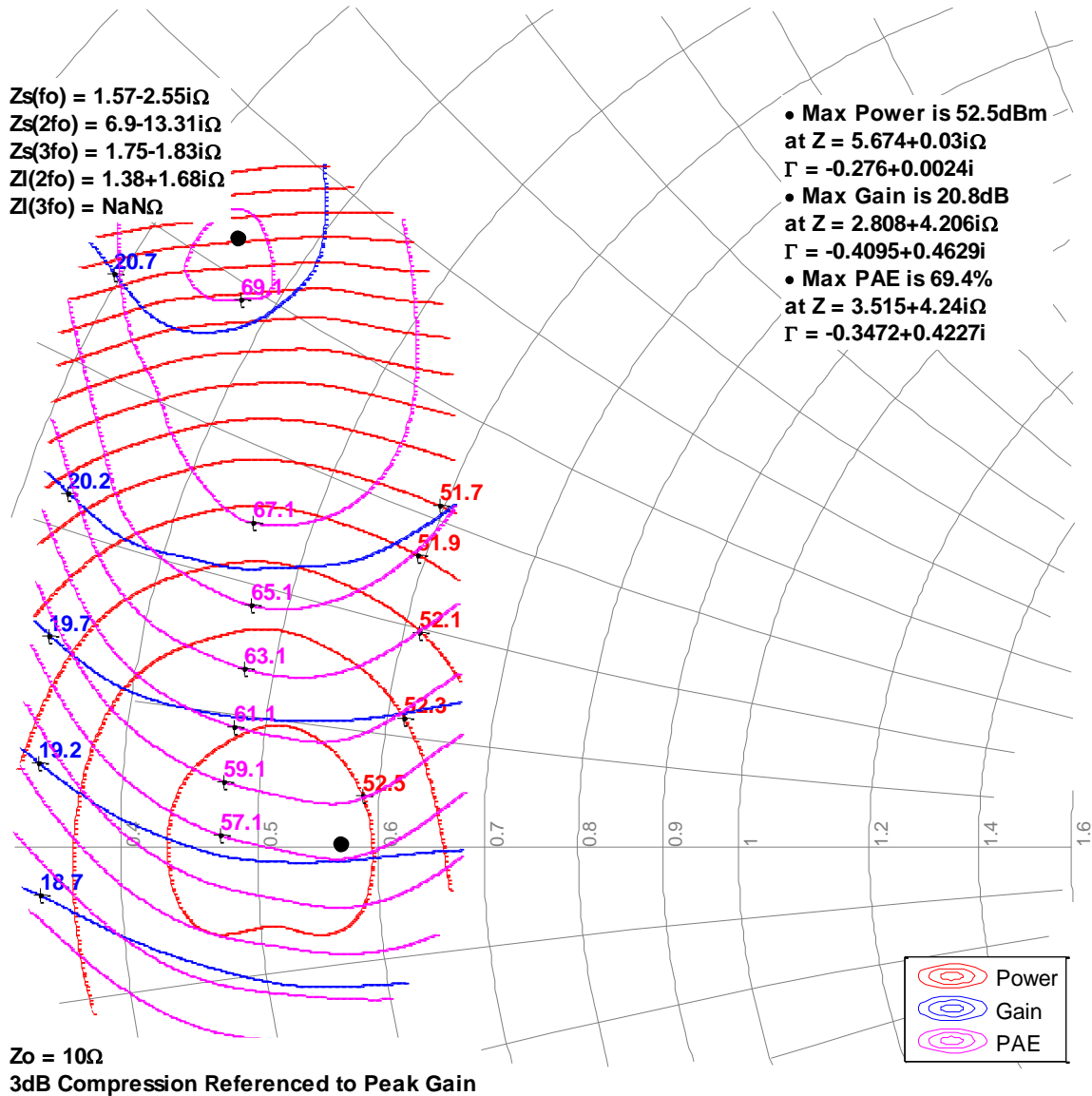


Load Pull Smith Charts^{1,2}

Notes:

1. $V_d = 65\text{ V}$, $I_{BQ} = 240\text{ mA}$, Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

1.5GHz, Load-pull

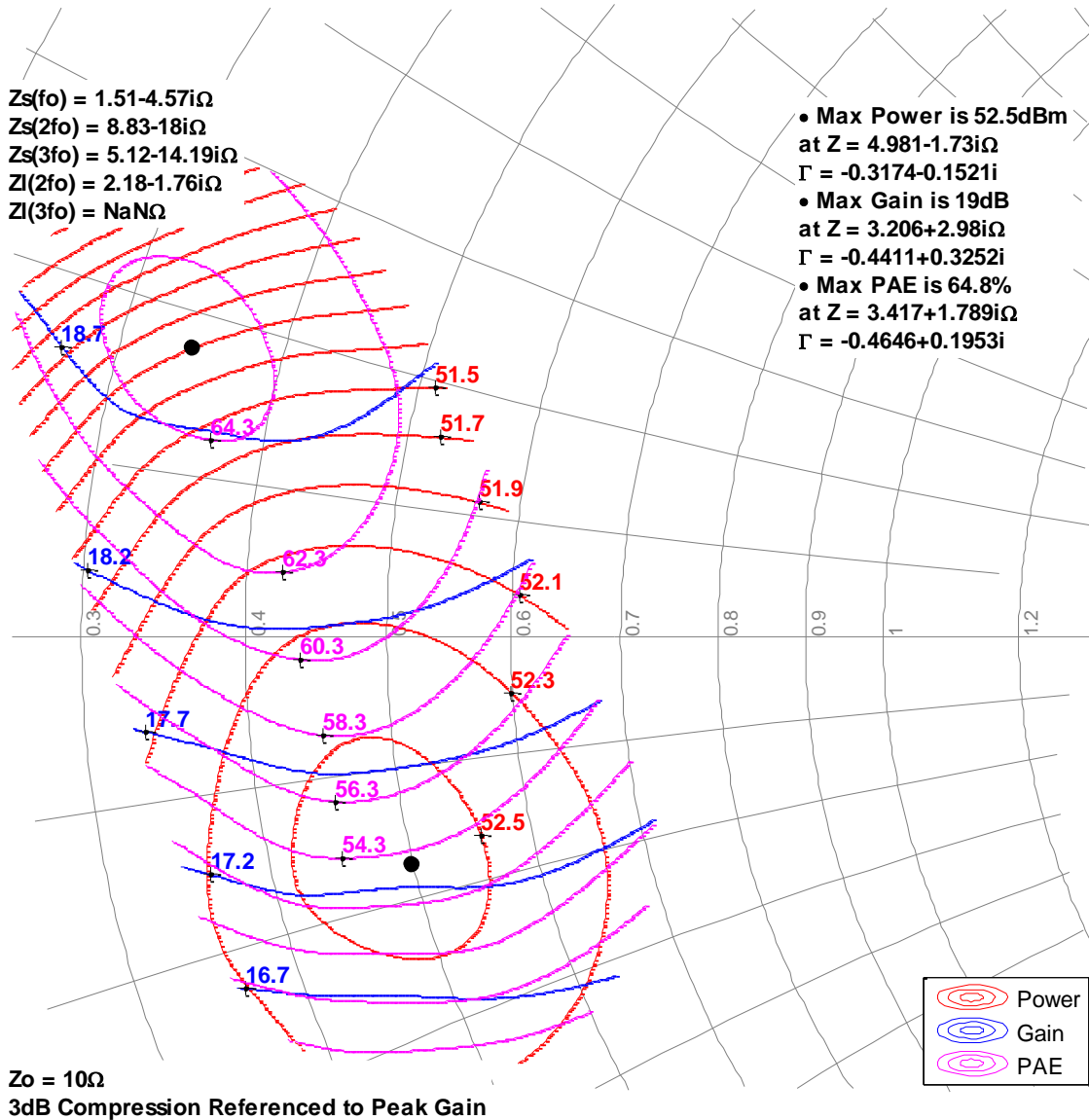


Load Pull Smith Charts^{1,2}

Notes:

1. $V_d = 65\text{ V}$, $I_{bQ} = 240\text{ mA}$, Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

1.8GHz, Load-pull

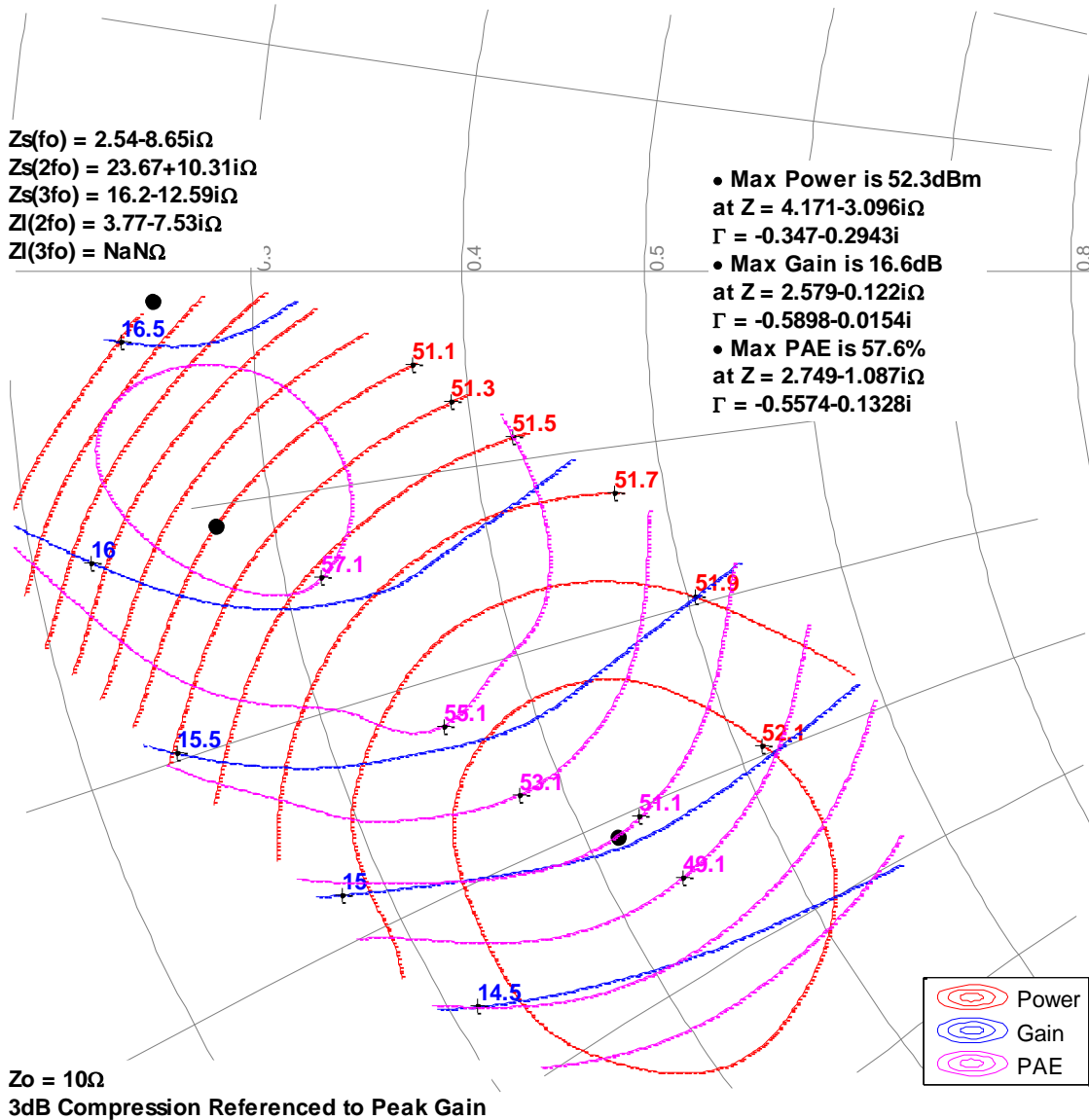


Load Pull Smith Charts^{1,2}

Notes:

1. $V_d = 65\text{ V}$, $I_{BQ} = 240\text{ mA}$, Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

2.3GHz, Load-pull

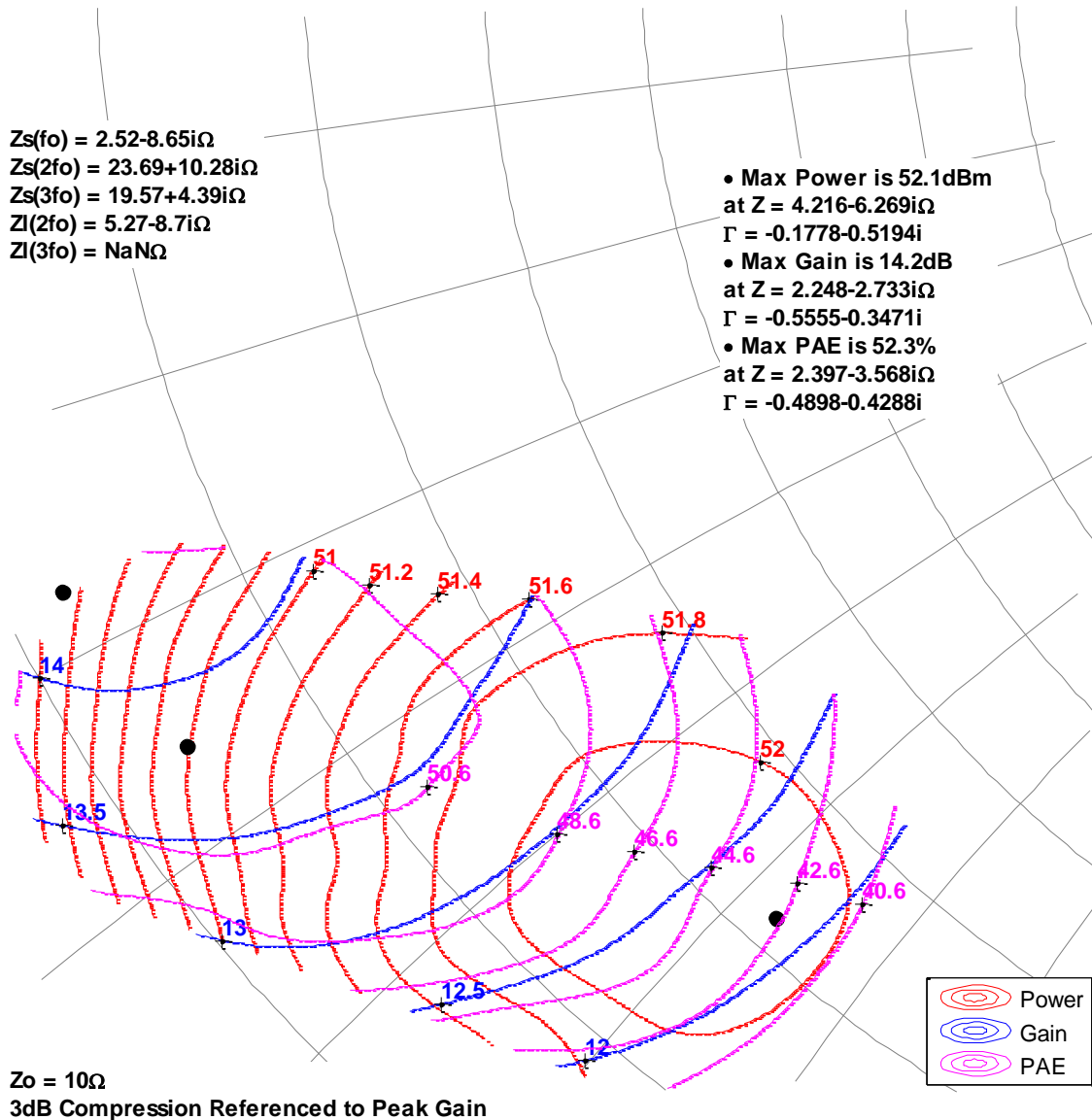


Load Pull Smith Charts^{1,2}

Notes:

1. $V_d = 65\text{ V}$, $I_{DQ} = 240\text{ mA}$, Pulsed signal with 100 us pulse width and 10 % duty cycle.
2. See page 20 for load pull and source pull reference planes.

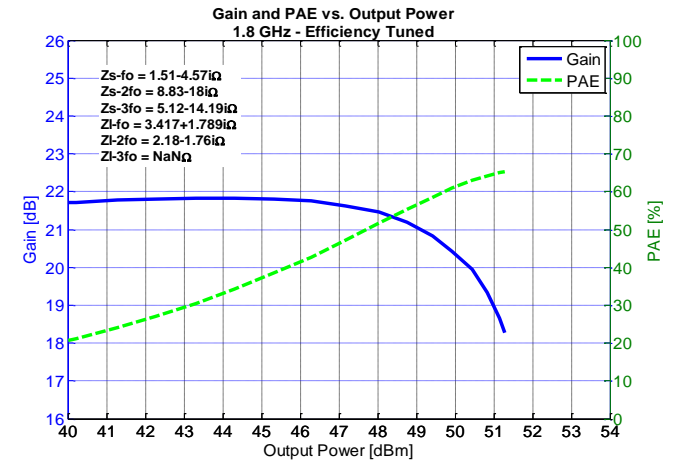
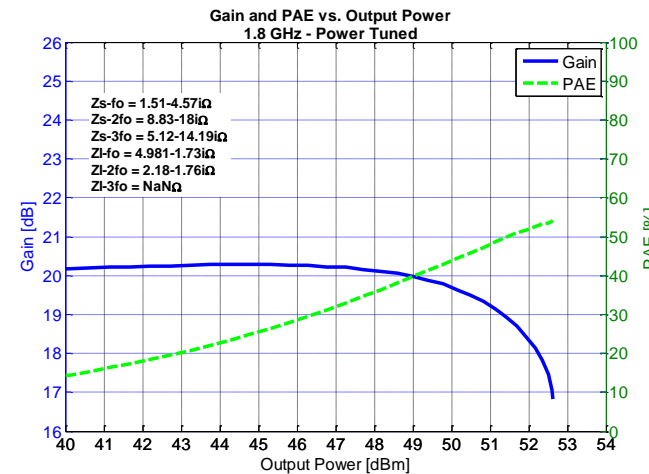
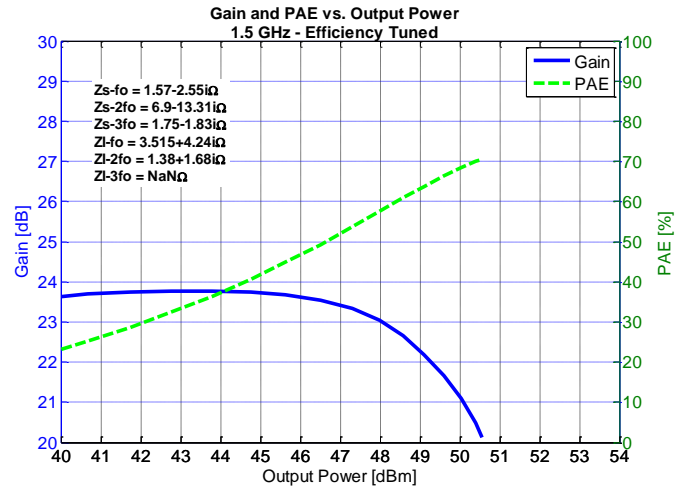
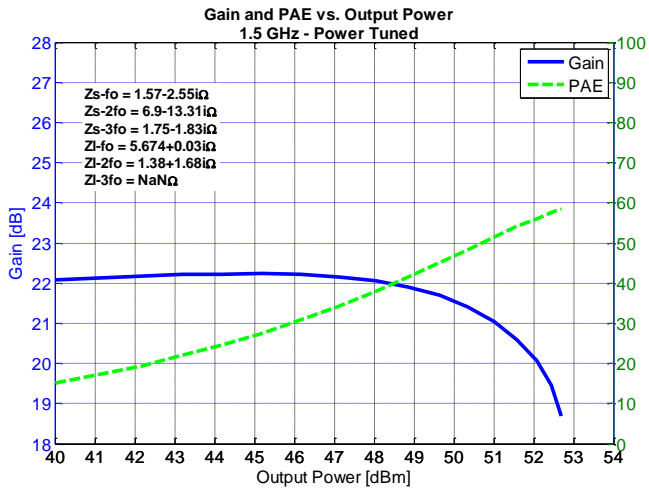
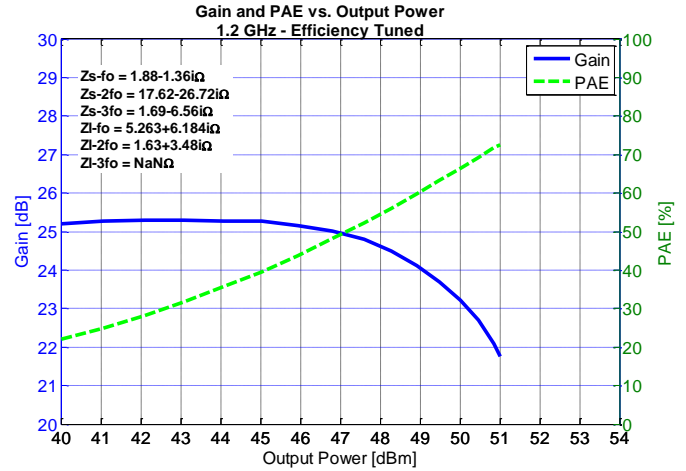
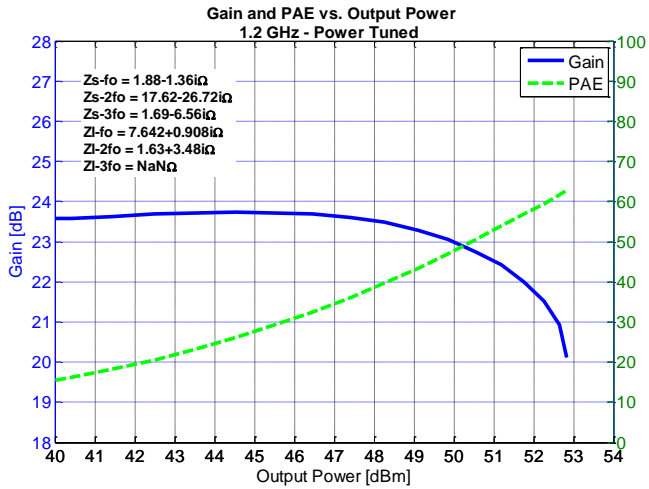
2.7GHz, Load-pull



Typical Performance – Load Pull Drive-up

Notes:

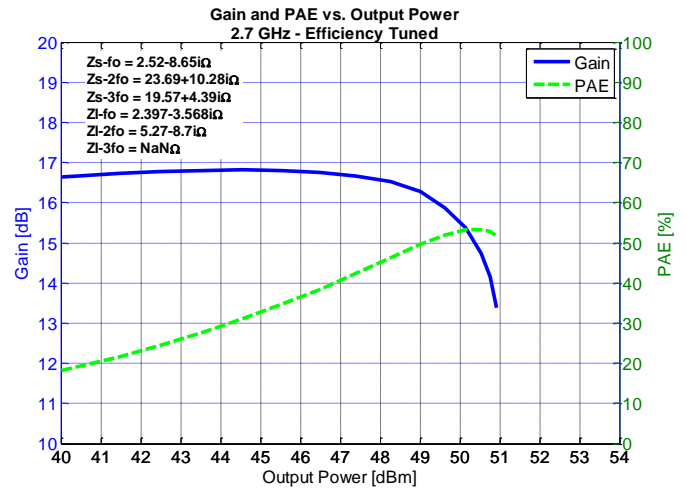
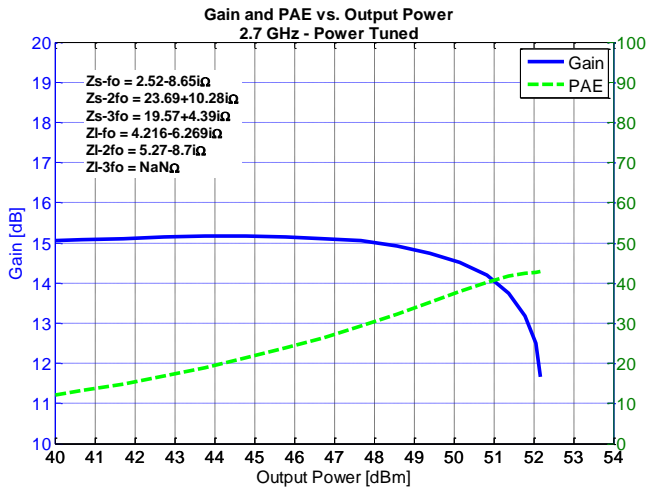
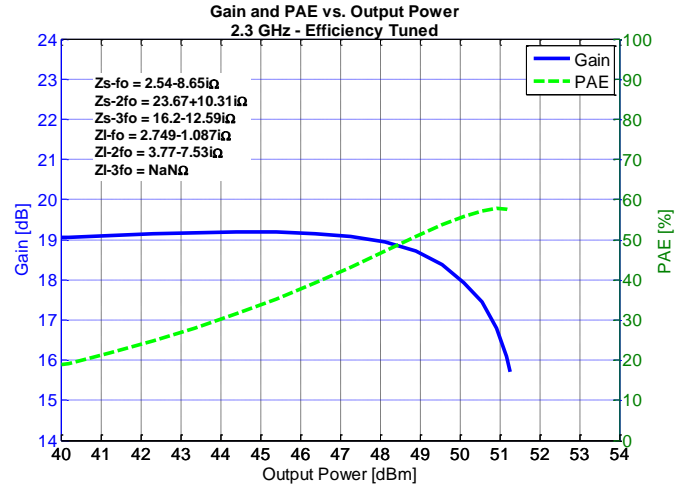
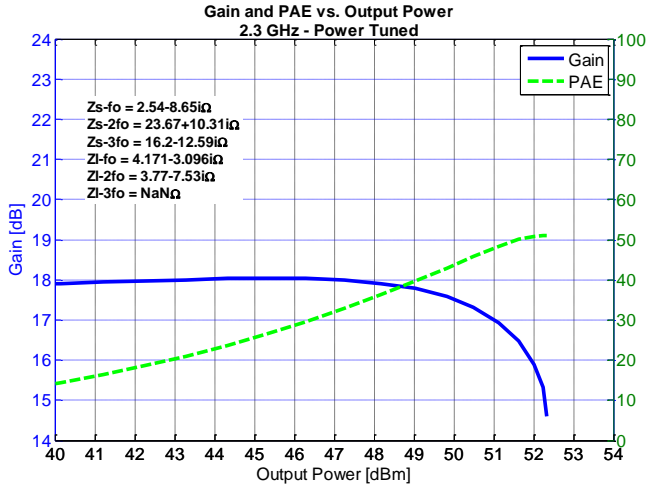
1. Pulsed signal with 100 us pulse width and 10 % duty cycle, $V_d = 65\text{ V}$, $I_{DQ} = 240\text{ mA}$
2. See page 20 for load pull and source pull reference planes where the performance was measured.



Typical Performance – Load Pull Drive-up

Notes:

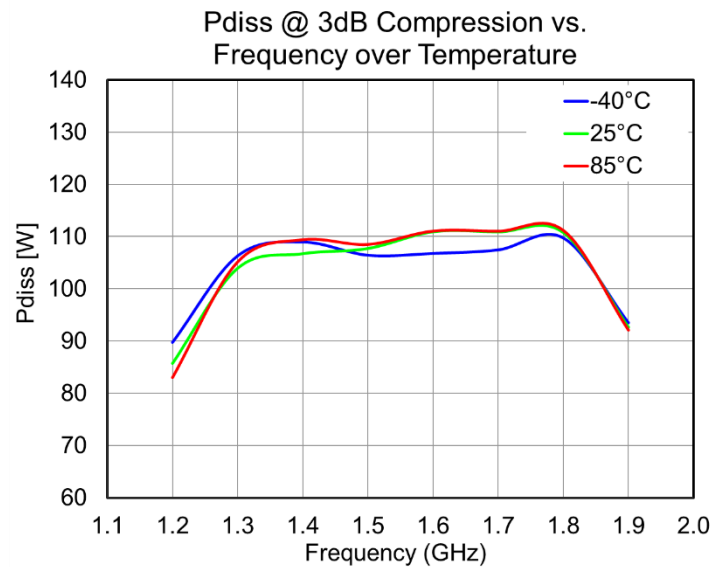
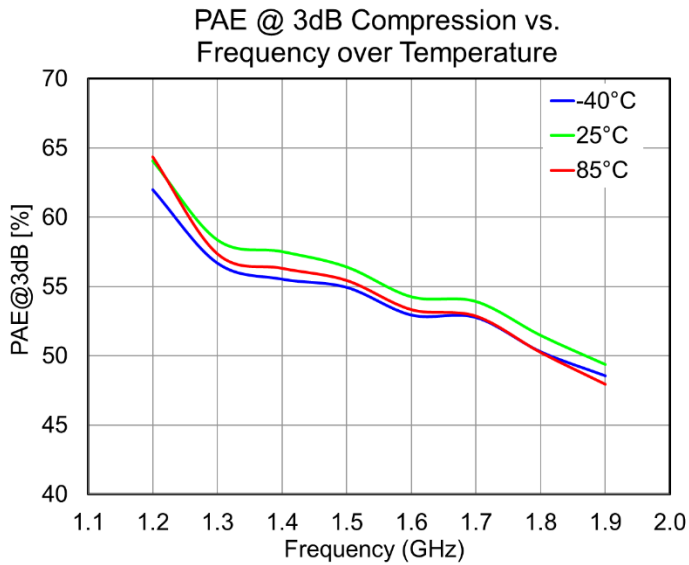
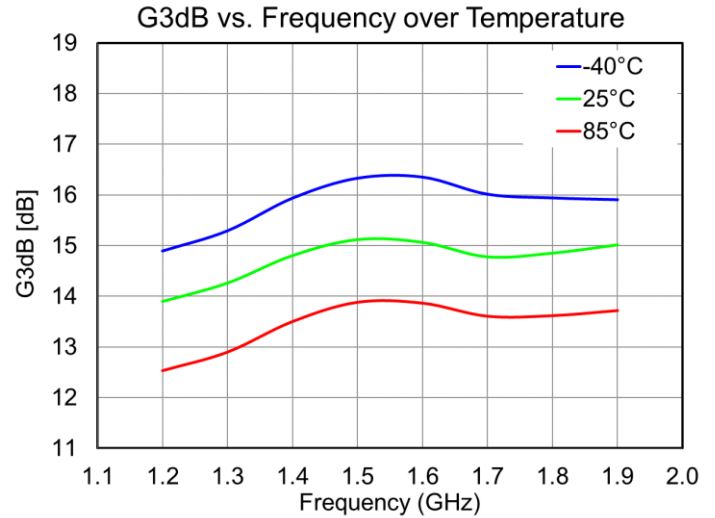
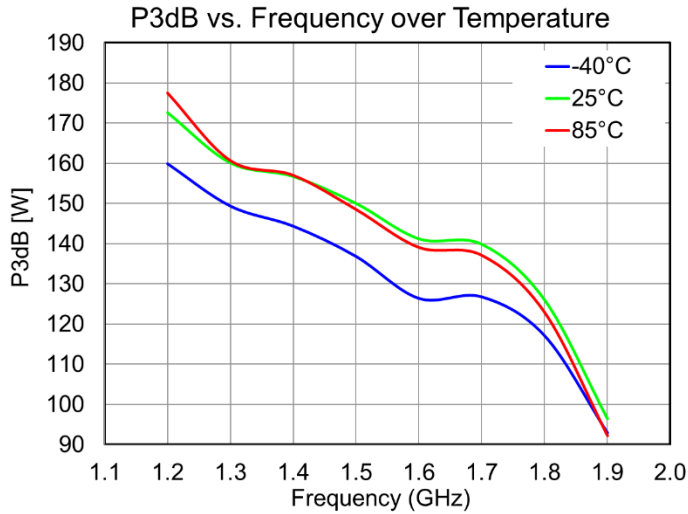
1. Pulsed signal with 100 us pulse width and 10 % duty cycle, $V_d = 65\text{ V}$, $I_{DQ} = 240\text{ mA}$
2. See page 20 for load pull and source pull reference planes where the performance was measured.



Power Driveup Performance Over Temperatures of 1.2 – 1.9 GHz EVB – 65 V¹

Notes:

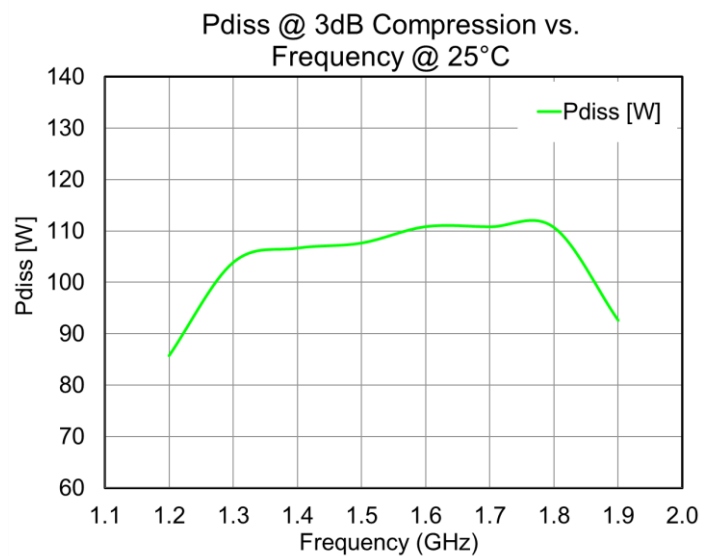
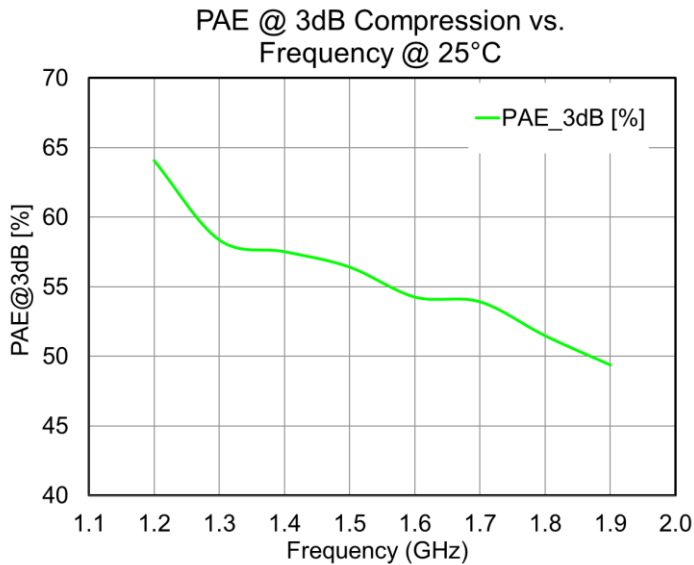
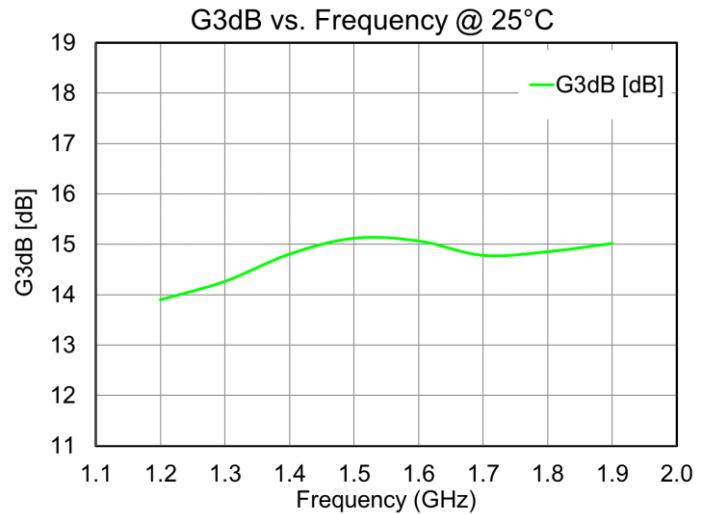
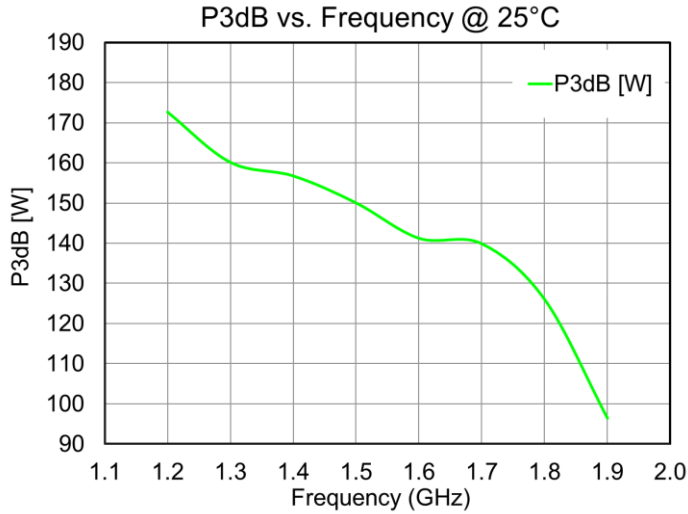
1- $V_d = 65\text{ V}$, $I_{DQ} = 240\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10 %



Power Driveup Performance at 25 °C of 1.2 – 1.9 GHz EVB – 65 V¹

Notes:

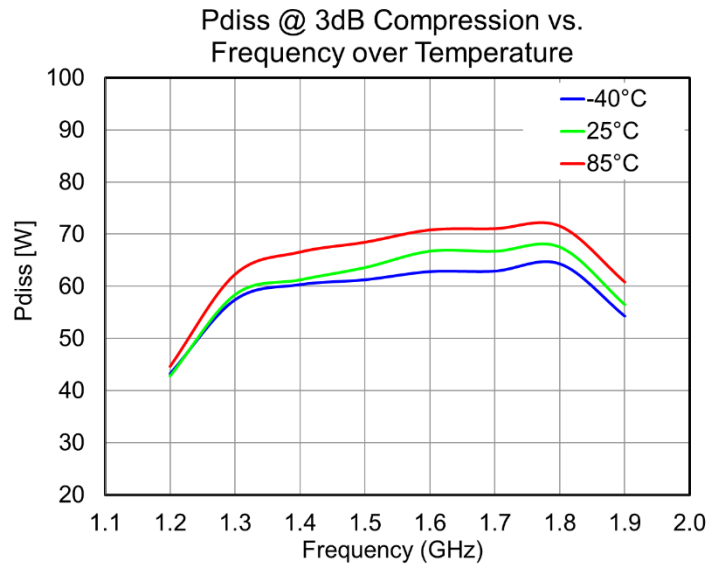
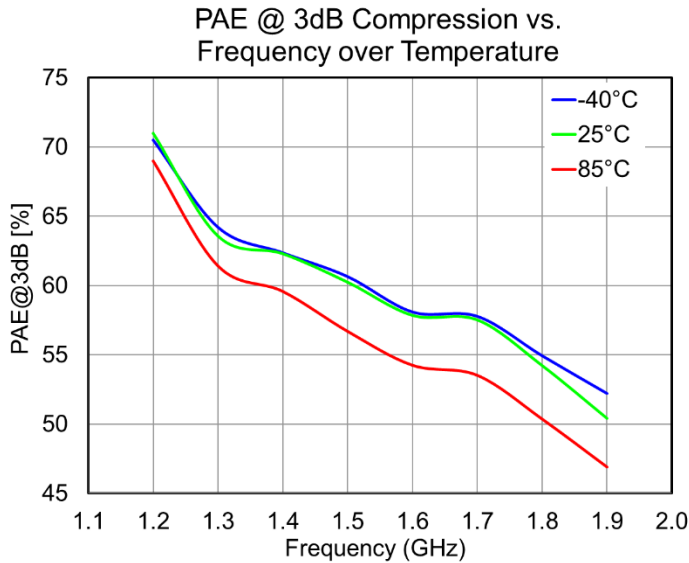
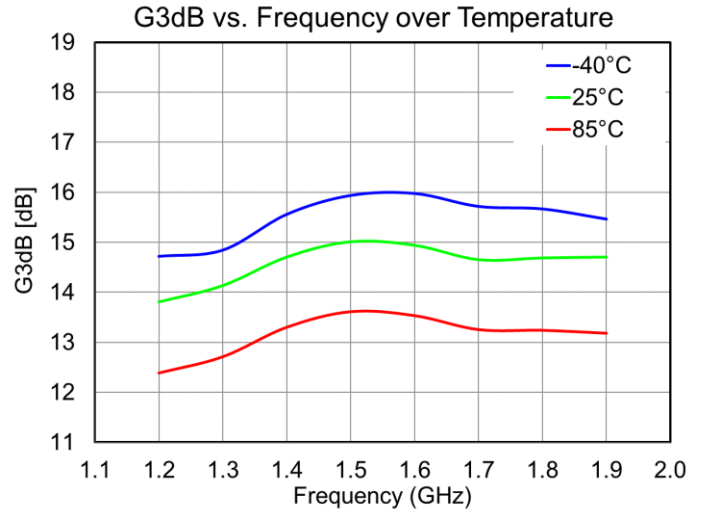
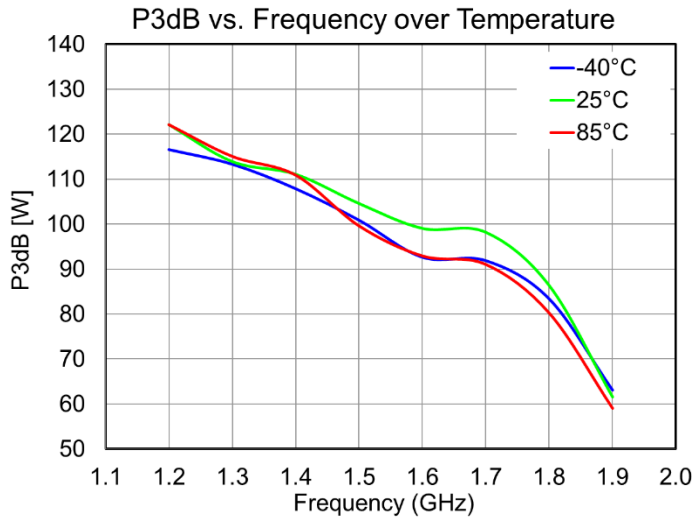
1- $V_d = 65\text{ V}$, $I_{BQ} = 240\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10 %



Power Driveup Performance Over Temperatures of 1.2 – 1.9 GHz EVB – 50 V¹

Notes:

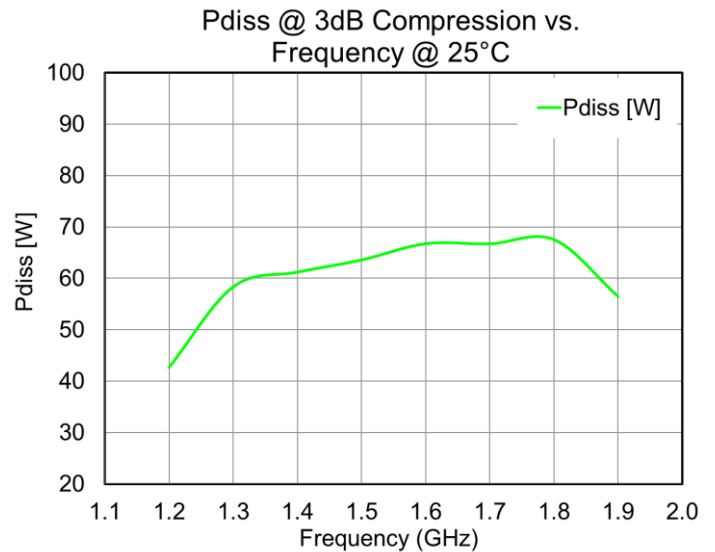
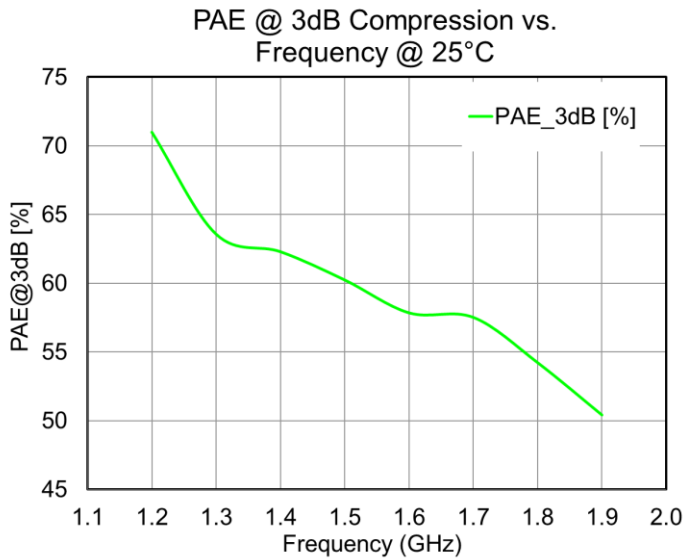
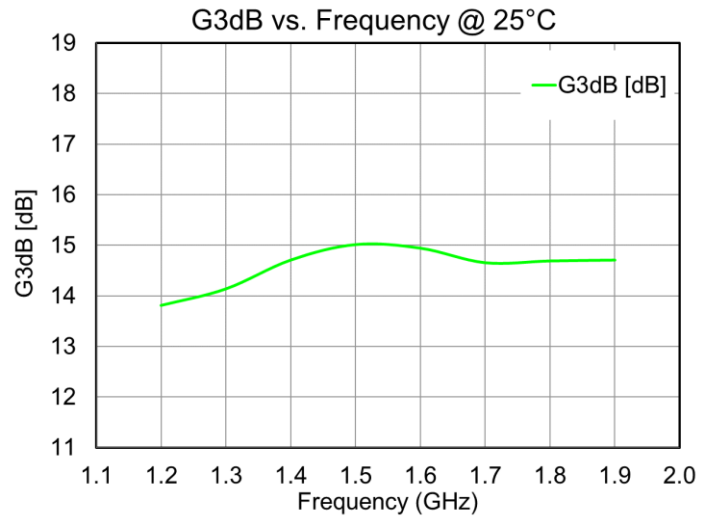
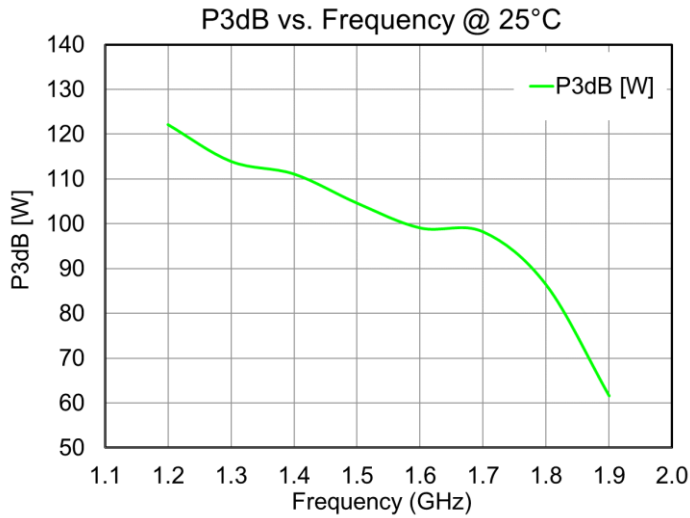
1- $V_d = 50\text{ V}$, $I_{BQ} = 240\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10 %



Power Driveup Performance at 25 °C of 1.2 – 1.9 GHz EVB – 50 V¹

Notes:

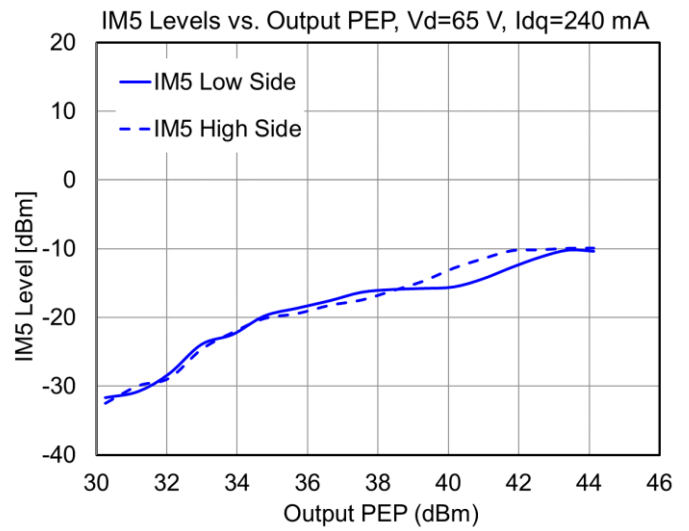
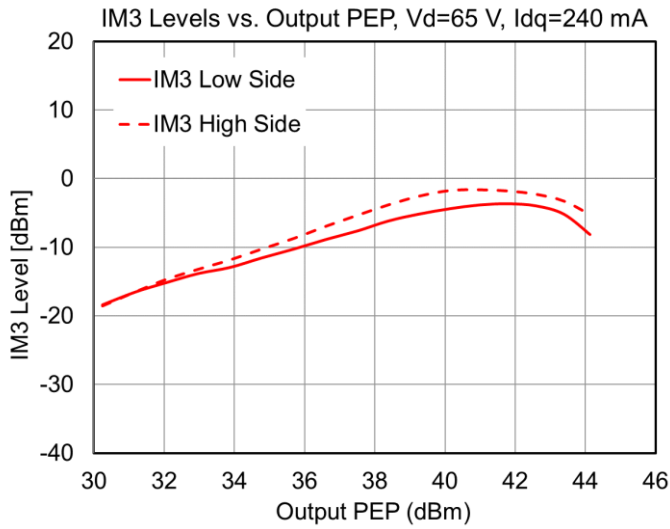
1- $V_d = 50\text{ V}$, $I_{BQ} = 240\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10 %



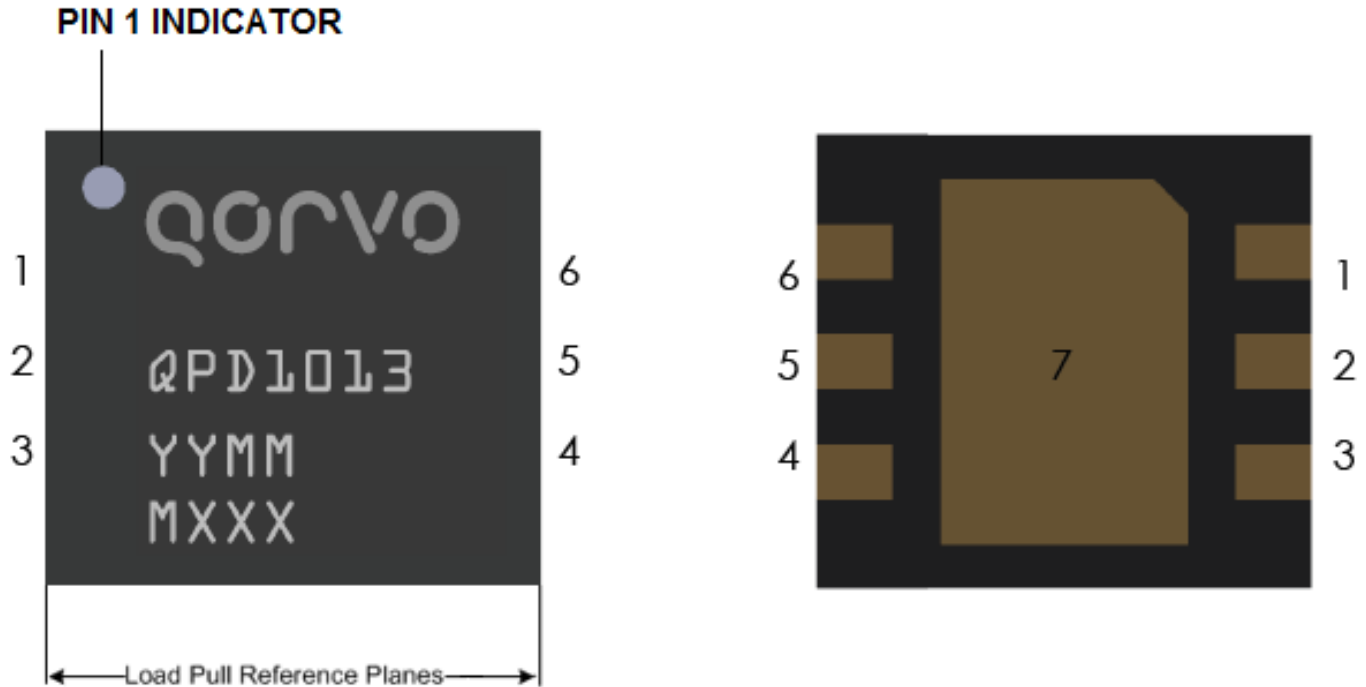
Two-Tone Performance at 25 °C of 1.2 – 1.9 GHz EVB¹

Notes:

- 1- Center Frequency = 1.5 GHz. Tone Separation = 1 MHz.



Pin Layout ¹



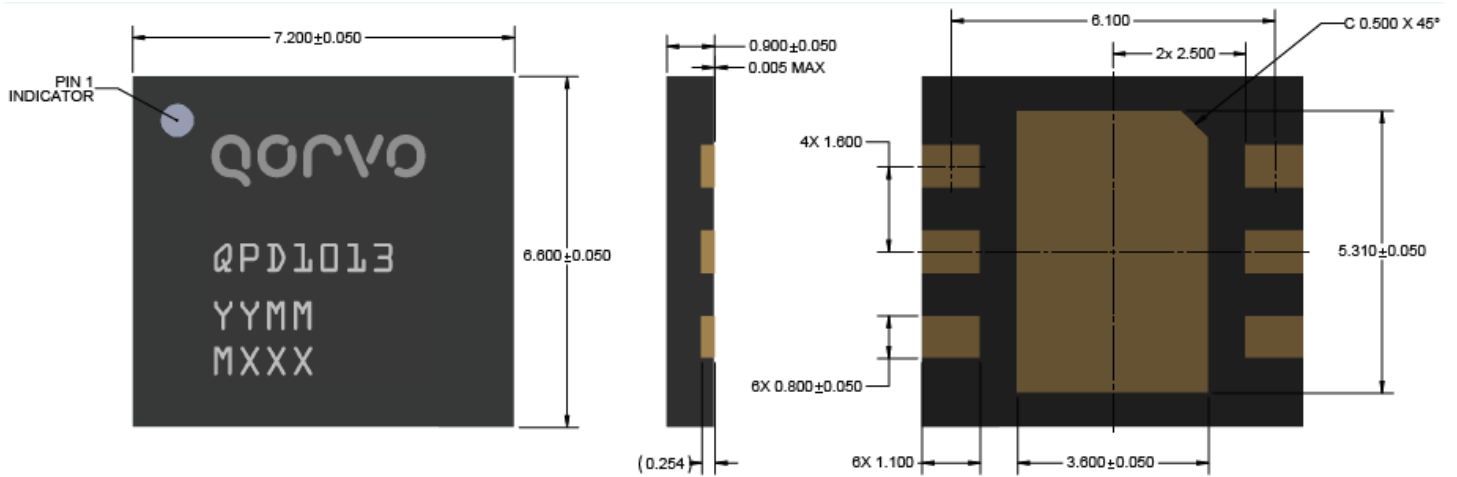
Notes:

- The QPD1013 will be marked with the “QPD1013” designator and a lot code marked below the part designator. The “YY” represents the last two digits of the calendar year the part was manufactured, the “MM” is the work week of the assembly lot start, the “MXXX” is the batch ID.

Pin Description

Pin	Symbol	Description
1 – 3	VG / RF IN	Gate voltage / RF Input
4 – 6	VD / RF OUT	Drain voltage / RF Output
7	Back Plane	Source to be connected to ground

Mechanical Drawing



Notes:

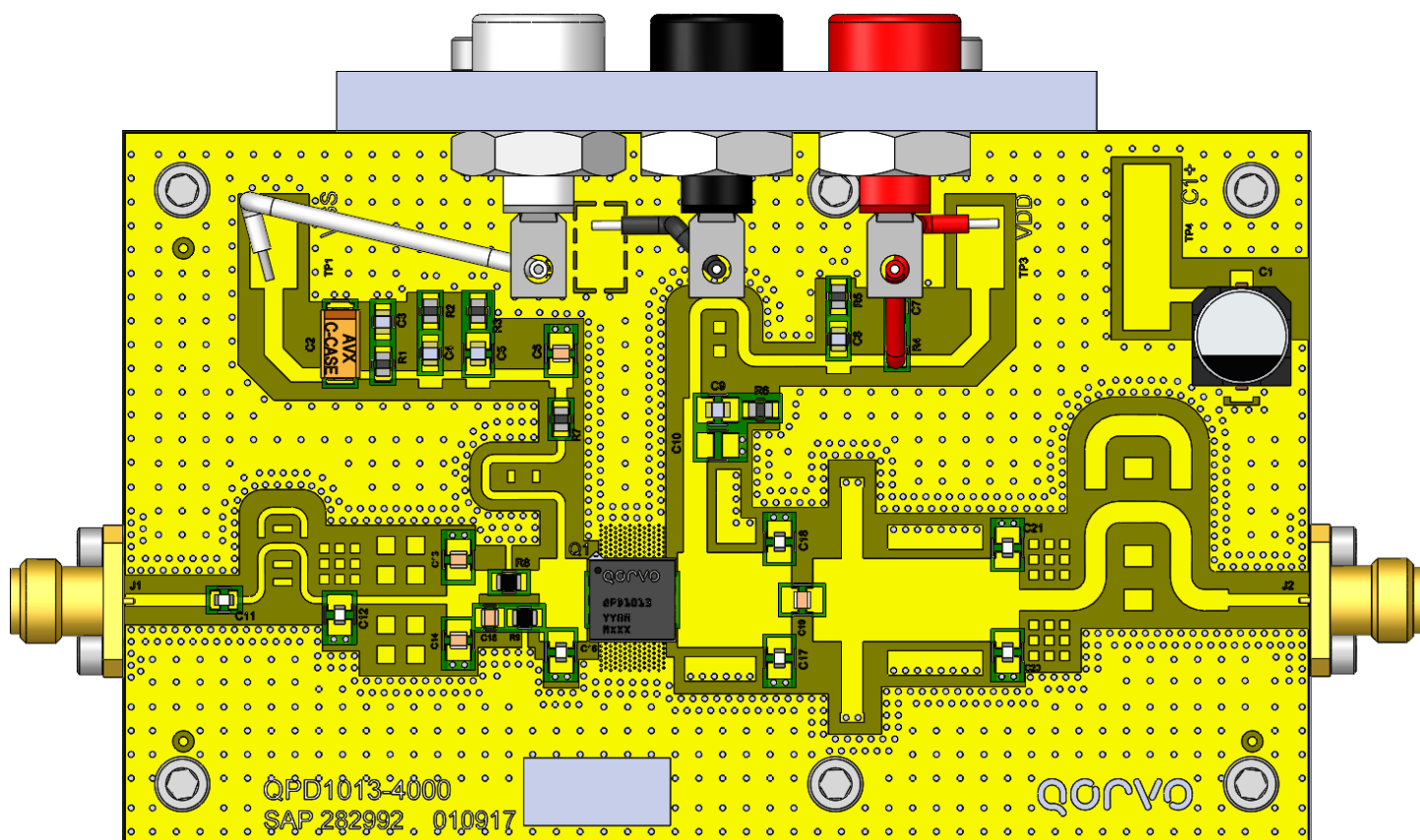
- 1- All dimensions are in mm, otherwise noted. Tolerance is ± 0.050 mm.

Bias-up Procedure	Bias-down Procedure
1. Set V_G to -4 V.	1. Turn off RF signal.
2. Set ID current limit to 500 mA.	2. Turn off VD
3. Apply 65 V VD.	3. Wait 2 seconds to allow drain capacitor to discharge
4. Slowly adjust VG until ID is set to 240 mA.	4. Turn off VG
5. Set ID current limit to 3 A	
6. Apply RF.	

PCB Layout – 1.2 – 1.9 GHz EVB¹

Notes:

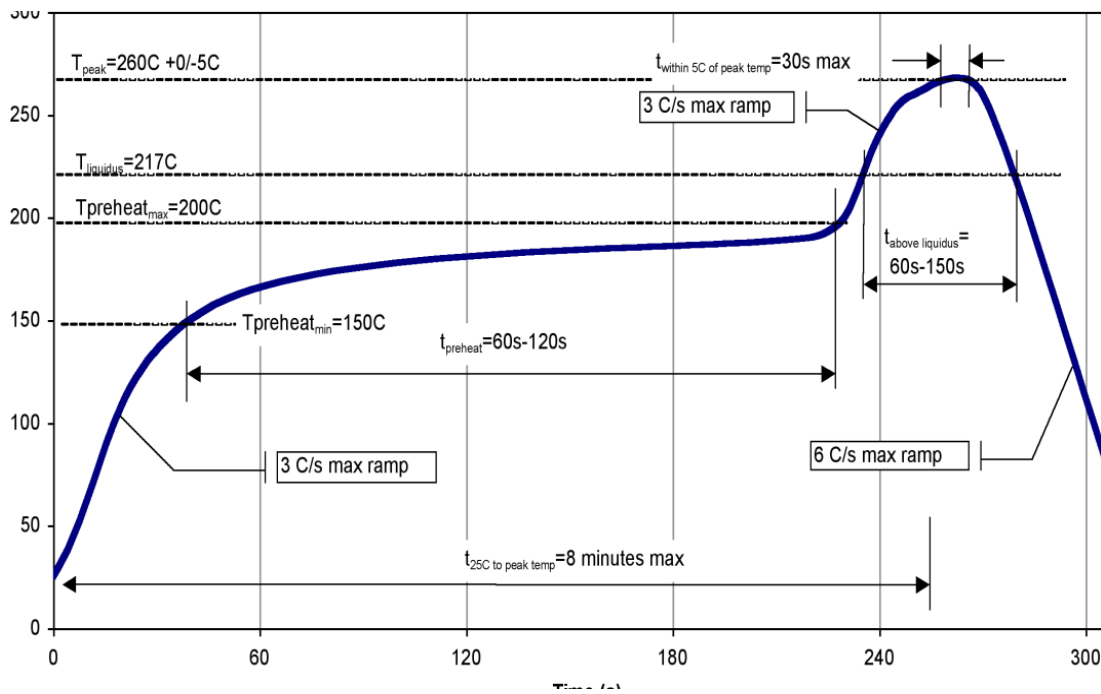
- 1- PCB Material is RO4350B, 20 mil thick substrate, 1 oz. copper each side.



Bill Of material – 1.2 – 1.9 GHz EVB

Ref Des	Value	Description	Manufacturer	Part Number
C4, C8	1.0 nF	X7R 100V 5% 0805 Capacitor	AVX	08051C102JAT2A
C3, C7	10.0 nF	X7R 100V 5% 0805 Capacitor	AVX	08051C103JAT2A
C20 – C21	1.5 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S1R5BT250XT
C13 – C14	1.2 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC800A1R2BT250XT
C12	2.0 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S2R0BT250XT
C16	3.6 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S3R6BT250XT
C17 – C18	3.9 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S3R9BT250XT
C11	4.7 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S4R7BT250XT
C15, C19	12.0 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC800A120JT250XT
C6	22.0 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC800A220JT250XT
C5, C9	100 pF	RF C0G 250VDC 5% Capacitor	ATC	ATC600F101JT250XT
C1	33 uF	80V 20% SVP Capacitor	Panasonic	EEEFK1K330P
C2	10 uF	16V 10% Tantalum Capacitor	AVX	TPSC106KR0500
J1 - 2	–	SMA Panel Mount 4-hole Jack	Gigalane	PSF-S00-000
R7	3.0 Ohm	0805 1% Thick Film Resistor	ANY	–
R1 – R6	5.1 Ohm	0805 1% Thick Film Resistor	ANY	–
R8	3.0 Ohm	0805 16W 5% Thick Film Resistor	IMS	NGC-0805CS3R00J
R9	5.0 Ohm	0805 16W 5% Thick Film Resistor	IMS	NGC-0805CS5R00J

Recommended Solder Temperature Profile



Product Compliance Information

ESD Sensitivity Ratings



Caution! ESD Sensitive Device

ESD Rating

ESD Rating: Class 1A
Value: 450 V
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

MSL Rating

MSL Rating: TBD
Test: 260 °C convection reflow
Standard: JEDEC Standard IPC/JEDEC J-STD-020

Solderability

Compatible with lead free soldering processes, 260 °C maximum reflow temperature.

Package lead plating: NiAu

The use of no-clean solder to avoid washing after soldering is recommended.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about Qorvo:

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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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